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(19) **United States**(12) **Patent Application Publication**  
**Nagami**(10) **Pub. No.: US 2015/0055038 A1**(43) **Pub. Date: Feb. 26, 2015**(54) **LIQUID CRYSTAL DISPLAY DEVICE****G02F 1/1333** (2006.01)**G02F 1/1362** (2006.01)(71) Applicant: **Japan Display Inc.**, Tokyo (JP)(52) **U.S. Cl.**(72) Inventor: **Takahiro Nagami**, Mobara (JP)CPC .... **G02F 1/134363** (2013.01); **G02F 1/136213**  
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**1/136286** (2013.01); **G02F 1/133345** (2013.01);  
**G02F 2001/13629** (2013.01)(21) Appl. No.: **14/533,591**USPC ..... **349/39**(22) Filed: **Nov. 5, 2014****Related U.S. Application Data**(63) Continuation of application No. 13/251,384, filed on  
Oct. 3, 2011, now Pat. No. 8,908,114.(30) **Foreign Application Priority Data**

Oct. 5, 2010 (JP) ..... 2010-225632

**Publication Classification**(51) **Int. Cl.****G02F 1/1343** (2006.01)**G02F 1/1368** (2006.01)(57) **ABSTRACT**

A liquid crystal display device includes a TFT substrate, an opposite substrate, and a liquid crystal between the TFT substrate and the opposite substrate. In the TFT substrate, there are formed in the following order, a first pixel electrode and a second pixel electrode, a first scan line and a second scan line which extend in a first direction and are arranged in a second direction, a first insulating film, a first video signal line and a second signal line which extend in a second direction and are arranged in the first direction, a second insulating film, and a common electrode. The first pixel electrode and the second pixel electrode are formed in an area surrounded by the first scan line, the second scan line, the first video signal line and the second video signal line.

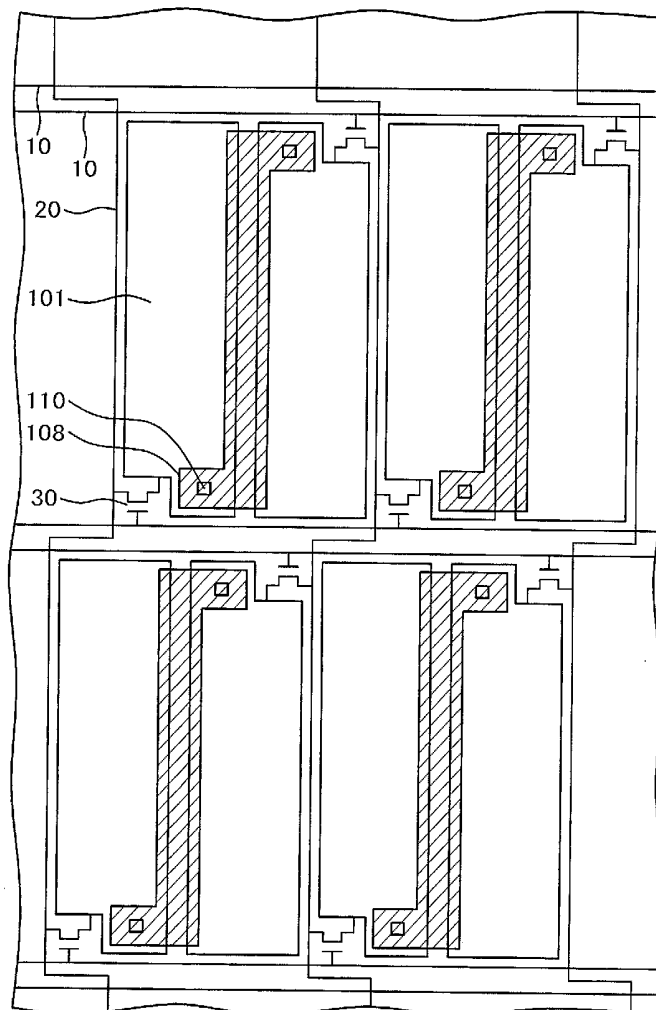


FIG. 1

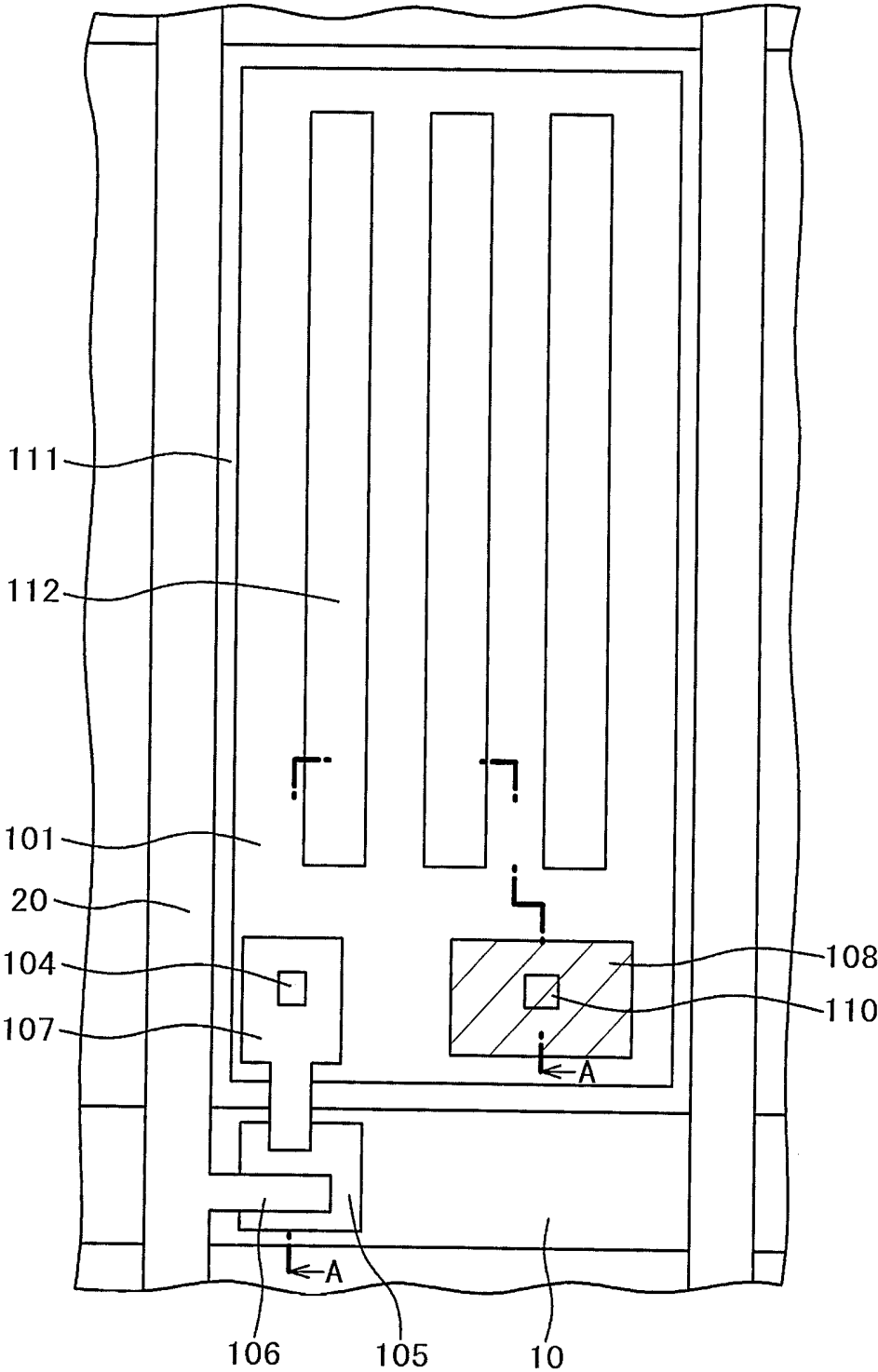


FIG. 2

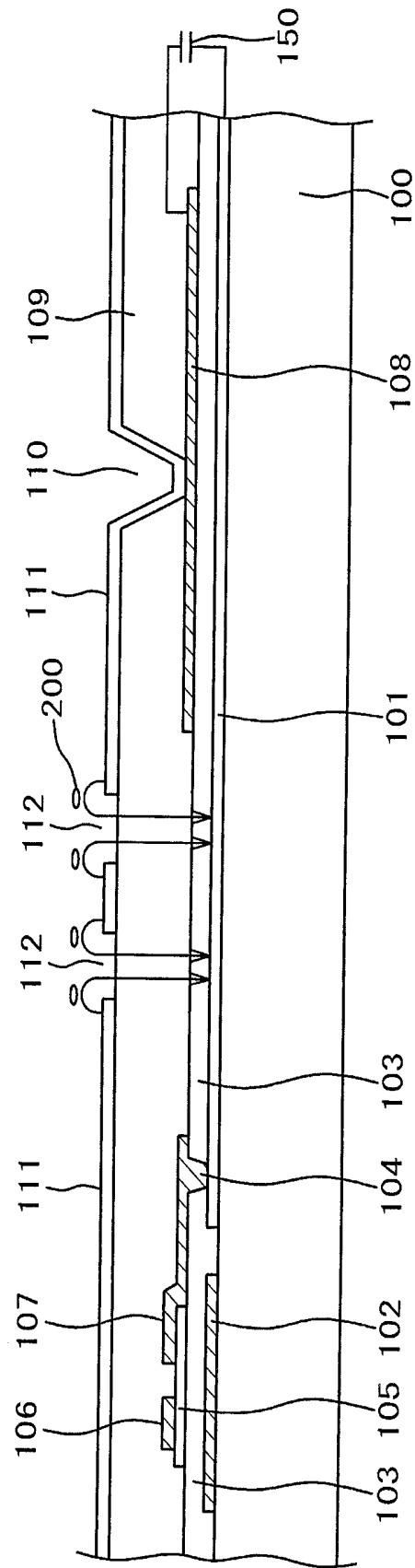


FIG. 3

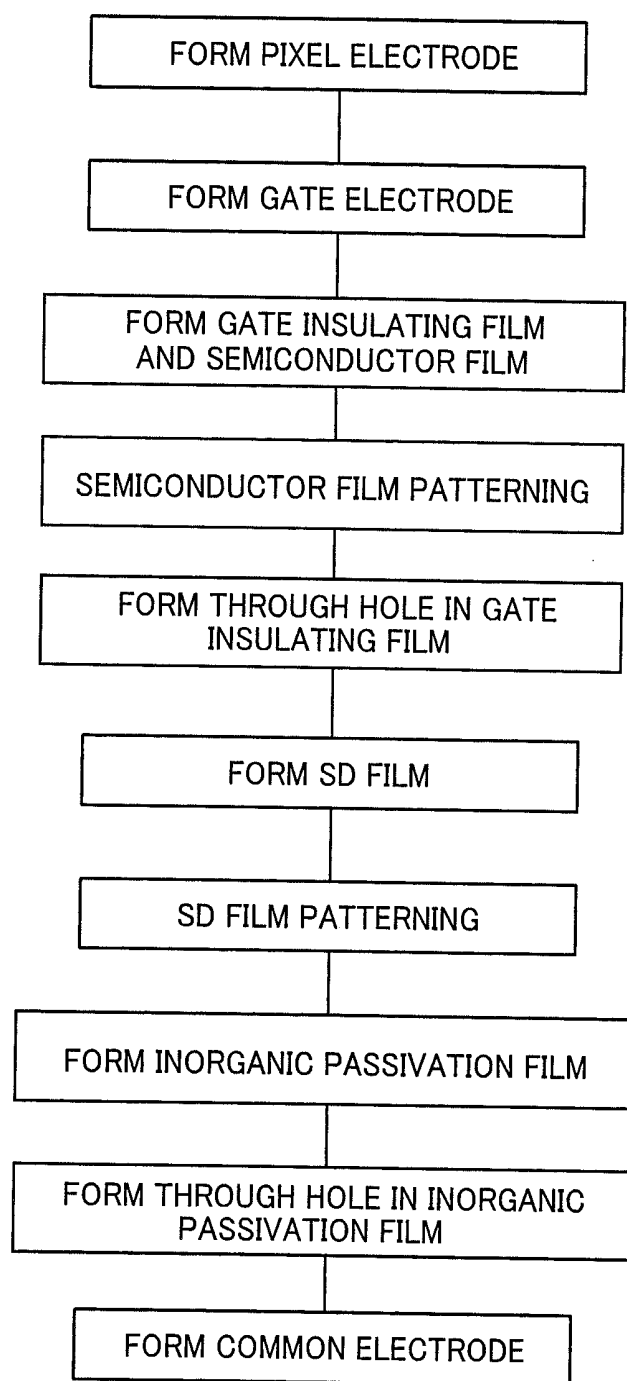


FIG. 4

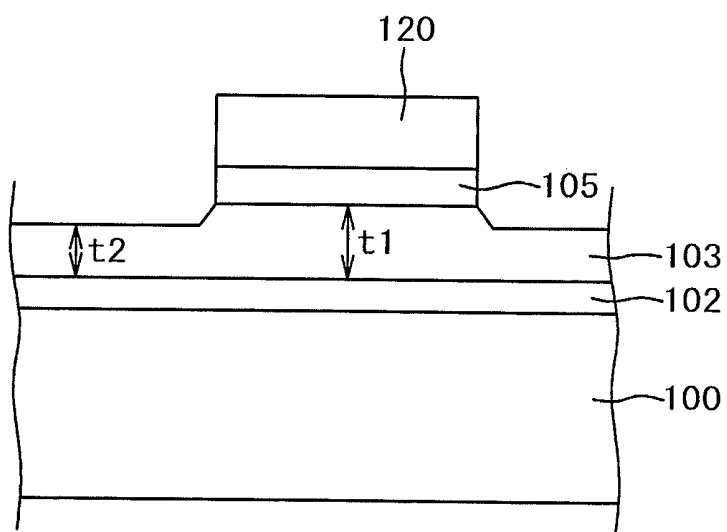


FIG. 5

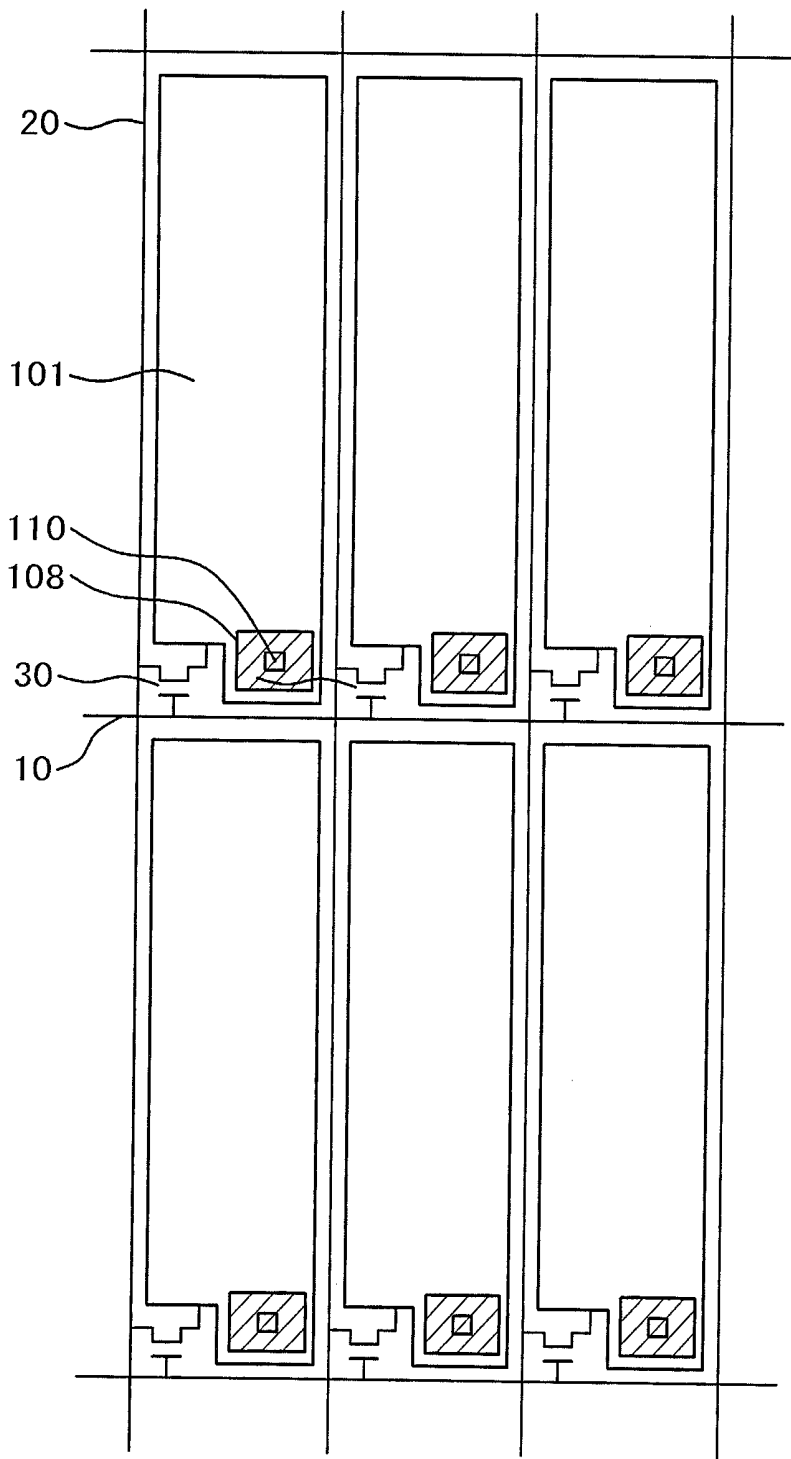


FIG. 6

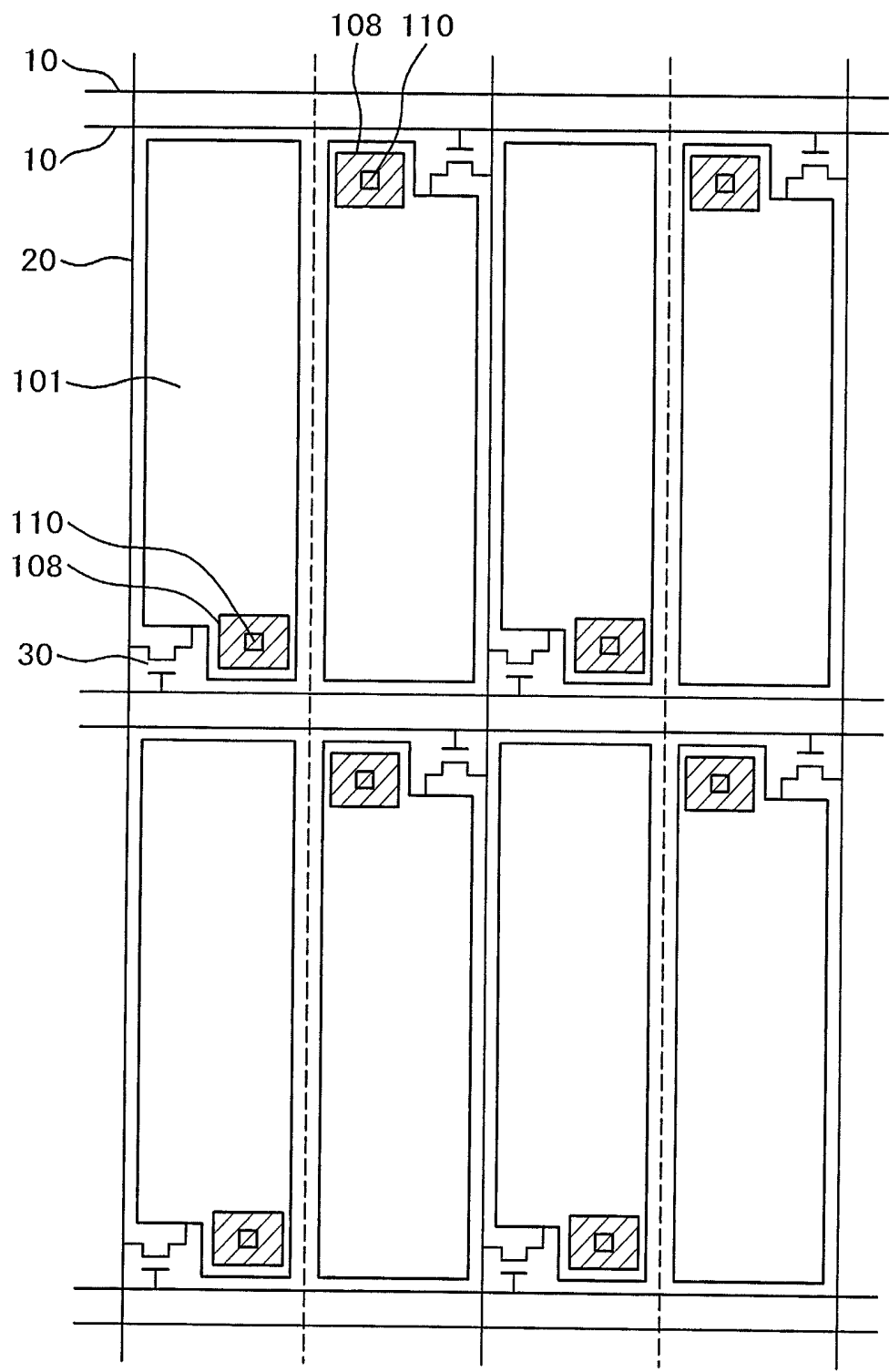


FIG. 7

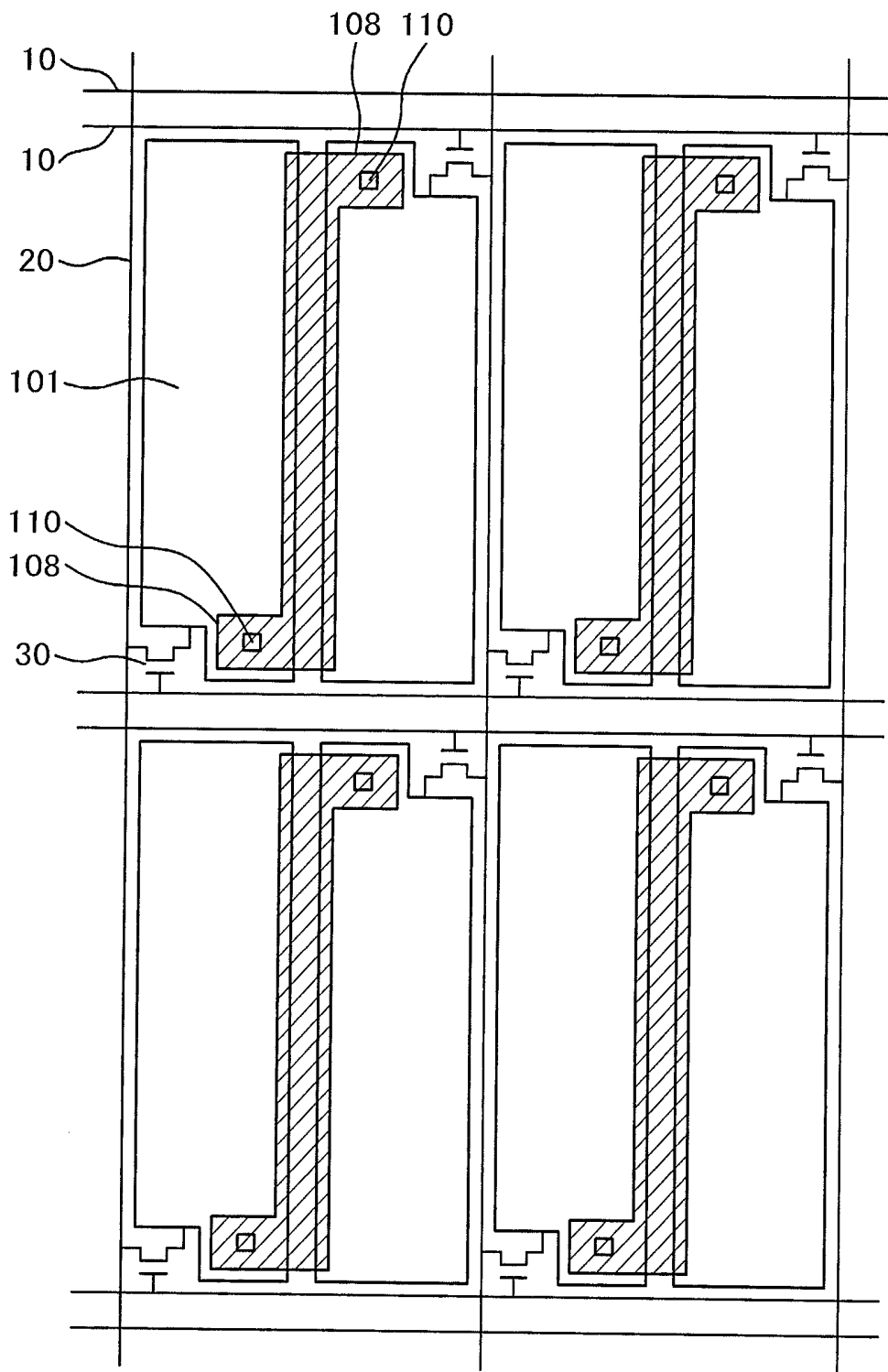


FIG. 8

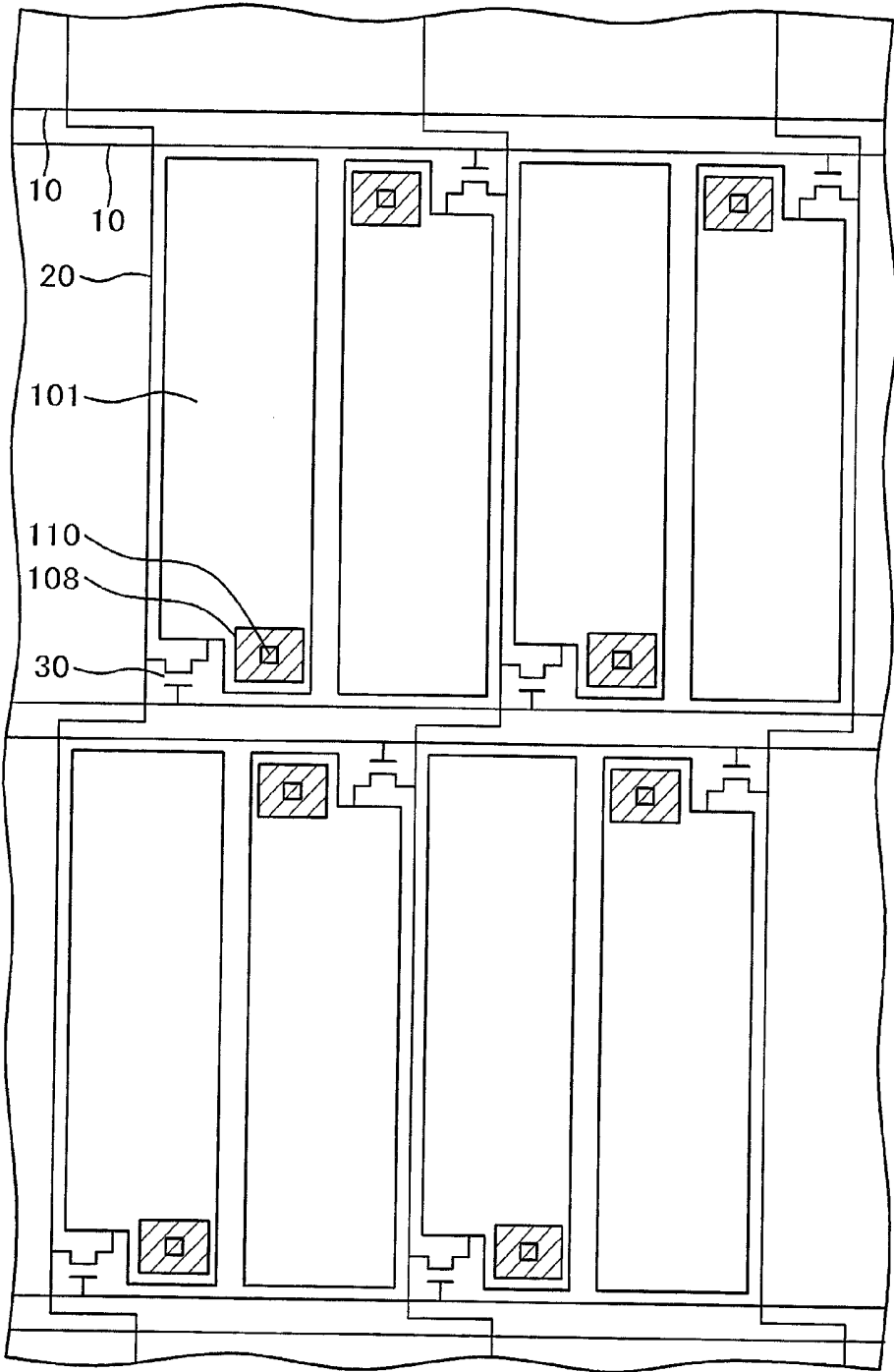


FIG. 9

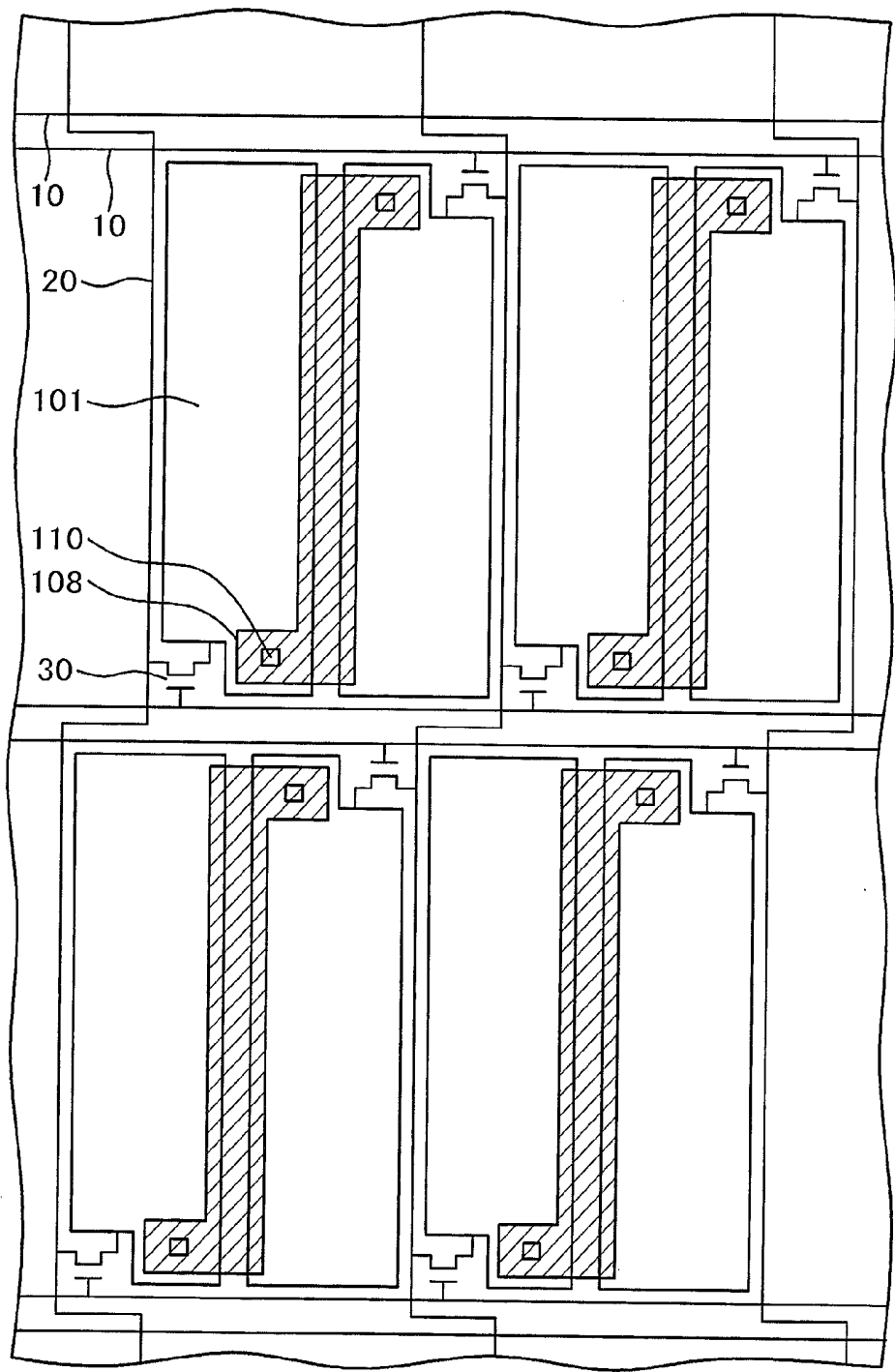


FIG. 10

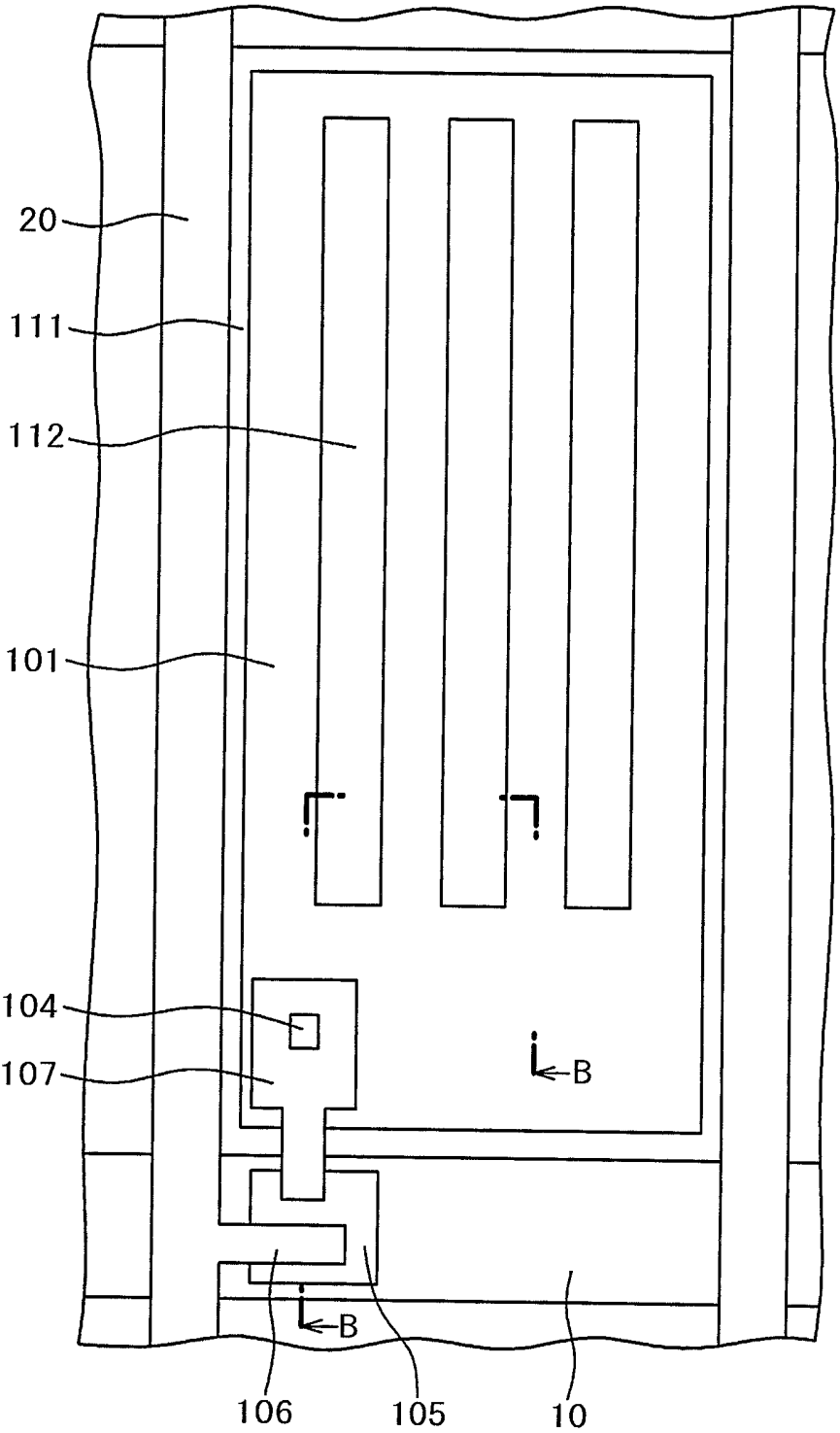
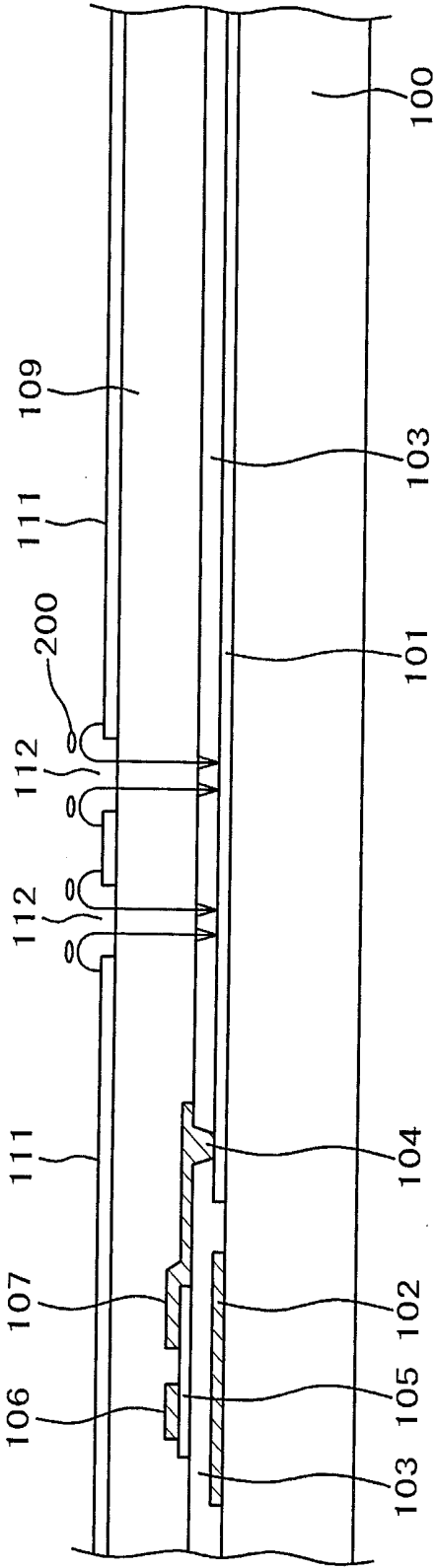


FIG. 11



## LIQUID CRYSTAL DISPLAY DEVICE

### CROSS REFERENCE TO RELATED APPLICATION

[0001] This application is a continuation of U.S. application Ser. No. 13/251,384, filed Oct. 3, 2011, the contents of which are incorporated herein by reference.

### CLAIM OF PRIORITY

[0002] The present application claims priority from Japanese Patent Application JP 2010-225632 filed on Oct. 5, 2010, the content of which is hereby incorporated by reference into this application.

### BACKGROUND OF THE INVENTION

[0003] 1. Technical Field

[0004] The present invention relates to a display device, and more particularly, to an IPS type liquid crystal display device having excellent visibility angle characteristic.

[0005] 2. Description of Related Art

[0006] A liquid crystal display panel used in a liquid crystal display device has a Thin Film Transistor (TFT) substrate, on which pixels each having a pixel electrode and a thin film transistor and the like are formed in matrix, and an opposite substrate facing the TFT substrate, on which color filters and the like are formed in positions corresponding to the pixel electrodes of the TFT substrate, and a liquid crystal held between the TFT substrate and the opposite substrate. An image is formed by controlling light transmittance through a liquid crystal molecule by pixel.

[0007] Since the liquid crystal display device is a flat and light-weight device, it is widely used in various fields. A small liquid crystal display device is used in many cellular phones and Digital Still Cameras (DSCs). The liquid crystal display device has a problem in its visibility angle characteristic. The visibility angle characteristic is a phenomenon that the luminance varies or chromaticity varies in accordance with view from front or diagonal direction. The visibility angle characteristic is excellent in In Plane Switching (IPS) method of operating a liquid crystal molecule with a horizontal direction electric field.

[0008] Various types of IPS methods exist; however, a main stream method is forming a common electrode or pixel electrodes solidly over a flat surface, arranging comb-shaped pixel electrode or common electrode on the common electrode, with an insulating film therebetween. The liquid crystal molecule is rotated with an electric field which occurs between the pixel electrode and the common electrode. With this method, the transmittance can be increased.

[0009] Conventionally, in the above IPS method, first, a TFT is formed, then the TFT is covered with a passivation film, then, the above-described common electrode, the insulating film, the pixel electrodes and the like are formed on the film. However, since there is a requirement for manufacturing cost reduction, the number of layers of the conductor film, the insulating film and the like in the TFT substrate is reduced.

[0010] As an example of another IPS method, Japanese Published Unexamined Patent Application No. 2009-168878 discloses forming a common electrode on the same layer of a gate electrode, and forming a comb-shaped pixel electrode, with a gate insulating film and a protective insulating film therebetween.

[0011] The pixel electrode is supplied with a video signal via the TFT. To prevent variation of the video signal in accordance with ON/OFF of gate voltage of the TFT, added capacitance is applied. In the conventional IPS, a comb-shaped pixel electrode and the common electrode, in nest relation, are used on the same flat surface. Japanese Published Unexamined Patent Application No. 2003-207796 discloses a structure of such IPS method using a top gate type TFT, in which a common electrode is formed to oppose an n+ region of a TFT semiconductor layer, with an inter-layer insulating film therebetween, with respect to the n+ region of the TFT semiconductor layer, so as to increase the added capacitance.

[0012] FIG. 10 is a plan view of an IPS pixel structure of the present invention. In FIG. 10, a pixel is formed in a region surrounded by a main scan line 10 and a video signal line 20. A TFT is formed on the main scan line 10. That is, a semiconductor film 105 is formed via a gate insulating film 103 on the main scan line 10, and a drain electrode 106 and a source electrode 107 are formed on the semiconductor film. The main scan line 10 is also used as a gate electrode. As shown in FIG. 11, in the present pixel structure, a pixel electrode 101 connected to the source electrode 107 of the TFT is formed in the bottom layer, while a common electrode 111 is formed in the top layer, to drive a liquid crystal molecule 200 with a voltage between the pixel electrode 101 and the common electrode 111.

[0013] FIG. 11 is a B-B cross sectional view of FIG. 10. In FIG. 11, a gate electrode 102 and the pixel electrode 101 are formed on the glass TFT substrate 100. The gate electrode 102 is an Al and AlMo alloy laminated layer film. The pixel electrode 101 is formed with Indium Tin Oxide (ITO). The gate insulating film 103 is formed so as to cover the gate electrode 102 and the pixel electrode 101.

[0014] An e-Si semiconductor film 105 is formed on the gate electrode 102 and the gate insulating film 103, and the drain electrode 106 and the source electrode 107 are formed on the semiconductor film. The source electrode 107 is connected to the pixel electrode 101 via a first through hole 104 formed in the gate insulating film 103. An inorganic passivation film 109 is formed to cover the drain electrode 106 and the source electrode 107. The common electrode 111 is formed on the inorganic passivation film 109. The common electrode 111 has a slit 112. When a voltage is applied between the pixel electrode 101 and the common electrode 111, an electric line of force occurs through the slit 112, to rotate the liquid crystal molecule 200, to control the quantity of light passing through a liquid crystal layer. In this manner, the IPS method, to which the present invention is applied, is very different from the structure of the liquid crystal display devices disclosed in the above-described Japanese Published Unexamined Patent Application Nos. 2009-168878 and 2003-207796.

[0015] FIG. 11 shows a structure where the number of layers is small and the number of photolithographic processes is small. This is an excellent structure in view of manufacturing cost. On the other hand, when added capacitance is formed between the pixel electrode 101 and the common electrode 111 to suppress voltage shift due to variation of gate voltage in the TFT, it is difficult to increase the added capacitance.

[0016] That is, in FIG. 11, the added capacitance is formed between the pixel electrode 101 and the common electrode 111, and the gate insulating film 103 and the inorganic passivation film 109 exist between the pixel electrode 101 and the

common electrode **111**. The gate insulating film **103**, having a thickness of about 240 nm, and the inorganic passivation film **109**, having a thickness of about 500 nm, are both formed with SIN. In this manner, since the added capacitance is formed via the insulating film having the total thickness of 740 nm, the added capacitance cannot be sufficiently increased. Accordingly, there is a problem of influence on the pixel voltage based on the ON/OFF of the gate voltage.

#### SUMMARY OF THE INVENTION

**[0017]** The present invention has been made so as to address the above-described problem and realize a low-cost IPS liquid crystal display device with a reduced the number of layers of laminated layer film and reduced pixel voltage shift.

**[0018]** According to the first aspect of the present invention, the foregoing object is attained by providing a liquid crystal display device having a TFT substrate, an opposite substrate, and a liquid crystal held between the TFT substrate and the opposite substrate, wherein in the TFT substrate, a scan line extends in a first direction and arranged in a second direction, a video signal line extends in the second direction and arranged in the first direction, and a pixel is formed between the scan line and the video signal line, wherein a pixel electrode is formed on the TFT substrate, a gate insulating film is formed on the pixel electrode, an inorganic passivation film is formed on the gate insulating film, a common electrode having a slit is formed on the inorganic passivation film, the liquid crystal is driven by supply of a video signal to the pixel electrode, wherein a capacitive electrode formed of metal or alloy is formed on the gate insulating film and under the inorganic passivation film, to be opposite to the pixel electrode, and wherein the pixel electrode is connected to the TFT, the capacitive electrode is connected to the common electrode, and the capacitive electrode and the pixel electrode form added capacitance.

**[0019]** In accordance with the present invention as described above, the pixel arrangement may be an in-line arrangement in a vertical direction of the screen or may be a delta arrangement.

**[0020]** According to the second aspect of the present invention, there is provided a liquid crystal display device having a TFT substrate, an opposite substrate, and a liquid crystal held between the TFT substrate and the opposite substrate, wherein in the TFT substrate, a pair of scan lines having a first scan line and a second scan line extends in a first direction and arranged in a second direction, a video signal line extends in the second direction and arranged in the first direction, and a first pixel and a second pixel are formed in the first direction between the pair of scan lines and the video signal line, wherein the first pixel is driven with the first scan line, and the second pixel is driven with the second scan line, wherein a first TFT is formed in correspondence with the first pixel, and a second TFT is formed in correspondence with the second pixel, wherein in the first pixel and the second pixel, a first pixel electrode and a second pixel electrode are respectively formed on the TFT substrate, a gate insulating film is formed on the pixel electrode, an inorganic passivation film is formed on the gate insulating film, a common electrode having a slit is formed on the inorganic passivation film, and the liquid crystal is driven by supply of a video signal to the pixel electrode, wherein a first capacitive electrode formed of metal or alloy is formed on the gate insulating film and under the inorganic passivation film, to be opposite to the first pixel electrode, wherein a second capacitive electrode formed of

metal or alloy is formed on the gate insulating film and under the inorganic passivation film, to be opposite to the second pixel electrode, wherein the first capacitive electrode is connected to the common electrode, to form first added capacitance with the first capacitive electrode and the first pixel electrode, and wherein the second capacitive electrode is connected to the common electrode, and the second capacitive electrode and the second pixel electrode form second added capacitance.

**[0021]** In accordance with the present invention as described above, the first pixel and the second pixel may be in an in-line arrangement in the second direction of the screen or may be in a delta arrangement. Further, the first capacitive electrode and the second capacitive electrode may be a serial electrode.

**[0022]** According to the present invention, in an IPS liquid crystal display device with a reduced number of layers, as the added capacitance can be increased, the variation of pixel electrode potential due to variation of the gate voltage can be suppressed.

#### BRIEF DESCRIPTION OF THE DRAWINGS

**[0023]** FIG. 1 is a plan view of a pixel in a liquid crystal display device according to the present invention;

**[0024]** FIG. 2 is a cross-sectional view of the pixel in the liquid crystal display device according to the present invention;

**[0025]** FIG. 3 is a flowchart showing a manufacturing process of the liquid crystal display device according to the present invention;

**[0026]** FIG. 4 is a cross-sectional view schematically showing a semiconductor film patterning state;

**[0027]** FIG. 5 illustrates a pixel arrangement in a first embodiment;

**[0028]** FIG. 6 illustrates a pixel arrangement in a second embodiment;

**[0029]** FIG. 7 illustrates a pixel arrangement in a third embodiment;

**[0030]** FIG. 8 illustrates a pixel arrangement in a fourth embodiment;

**[0031]** FIG. 9 illustrates a pixel arrangement in a fifth embodiment;

**[0032]** FIG. 10 is a plan view of a pixel in a liquid crystal display device according to a conventional technique; and

**[0033]** FIG. 11 is a cross-sectional view of the pixel in the liquid crystal display device according to the conventional technique.

#### DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

**[0034]** Preferred embodiments of the present invention will now be described in detail in accordance with the accompanying drawings.

##### First Embodiment

**[0035]** FIG. 1 is a plan view of a pixel part in a liquid crystal display device according to the present invention. Basically, the pixel structure is the same as that described in FIG. 10. That is, the gate insulating film **103** shown in FIG. 2 is formed on the main scan line **10** which also serves as a gate electrode, then the semiconductor film **105** is formed on the gate insulating film, and the drain electrode **106** and the source electrode **107** branched from the video signal line **20** are formed

on the semiconductor film. The source electrode **107** is connected to the pixel electrode **101** formed in the bottom layer via the first through hole **104**.

[0036] The inorganic passivation film **109** shown in FIG. 2 is formed to cover the source electrode **107** and the drain electrode **106**, and the common electrode **111** is formed on the passivation film. The common electrode **111** has the slit **112**. The common electrode **111** covers the entire surface in FIG. 1 except the slit. The difference of FIG. 1 from FIG. 10 is that the capacitive electrode **108** is formed on the gate insulating film **103**. The capacitive electrode **108** is connected to the common electrode **111** via the second through hole **110** formed in the inorganic passivation film **109**. The capacitive electrode **108** is opposite to the pixel electrode **101** via the gate insulating film **103**, and forms the added capacitance **150**.

[0037] FIG. 2 is an A-A cross section of FIG. 1. FIG. 3 is a process diagram corresponding to FIG. 2. Next, FIG. 2 will be described with reference to FIG. 3. First, the pixel electrode **101** is formed on the TFT substrate **100**. The pixel electrode **101** is formed by sputtering an ITO to have a thickness of e.g. 77 nm or 50 nm. Then the pixel electrode **101** is subjected to patterning. Next, the gate electrode **102** is formed by sputtering to have a thickness of about 220 nm. The gate electrode **102** is e.g. a laminated film in which a lower layer is an Al film having a thickness of 200 nm, and an upper layer is an AlMo alloy having a thickness of about 20 nm. In this manner, the pixel electrode **101** and the gate electrode **102** in the same layer are formed on the TFT substrate **100**.

[0038] Next, an a-Si film as the gate insulating film **103** and the semiconductor film **105** is continuously formed by CVD. Note that at this time, an n+a-Si (not shown) layer for ohmic contact is formed continuously from the a-Si. The thickness of the gate insulating film **103** is about 350 nm; that of the a-Si film is 150 nm; and that of the n+a-Si layer, about 50 nm.

[0039] Next, patterning is performed so as to form the semiconductor film **105** in an island shape as shown in FIG. 1. The semiconductor film **105** is formed on the gate insulating film **103**, and the patterning of the semiconductor layer is performed by photolithography. FIG. 4 shows a state prior to formation of resist **120** on the semiconductor film **105** and etching to remove the resist **120**. Since the etchant for the semiconductor film **105** somewhat etches the gate insulating film **103**, a thickness  $t_2$  of the gate insulating film **103** is thinner than a thickness  $t_1$  of the gate insulating film **103** under the semiconductor film **105**, as shown in FIG. 4.

[0040] The difference between the thickness  $t_1$  and the thickness  $t_2$  can be controlled in accordance with an etching condition. The thickness  $t_1$  of the gate insulating film **103** upon formation by CVD is about 350 nm. As described later, in the present invention, in etching of the semiconductor film **105**, the gate insulating film **103** except the TFT part is thinned to e.g. about 240 nm so as to increase the added capacitance **150**. With this process, the thickness of the gate insulating film **103** except the TFT part can be controlled to about 200 nm to 300 nm. Thereafter, the first through hole **104** is formed in the gate insulating film **103**. The TFT source electrode **107** and the pixel electrode **101** can be connected via the first through hole **104**.

[0041] Next, as an SD (source, drain) film, a CrMo film is formed by sputtering to have a thickness of about 150 nm to 200 nm. Then the SD film is subjected to patterning. In the middle of the patterning of the SD film, etching is performed

on a channel part of the TFT so as to remove n+a-Si in this part. Note that the SD film is not limited to CrMo but another metal or alloy may be used.

[0042] In the present invention, the SD film is used as not only the TFT source electrode **107** and the drain electrode **106**, but also as the capacitive electrode **108** for the added capacitance **150** as shown in FIG. 2. That is, when the source electrode **107** and the drain electrode **106** are formed, the capacitive electrode **108** is formed at the same time. As shown in FIG. 2, the capacitive electrode **108** is opposite to the pixel electrode **101**, with the gate insulating film **103** thinned in the patterning of the semiconductor film **105** therebetween.

[0043] Thereafter, the inorganic passivation film **109** is formed by CVD. The inorganic passivation film **109** is formed with e.g. SiN to have a thickness of about 500 nm. It is necessary to have a predetermined or thicker film thickness to have a function of a passivation film. Then, a second through hole **110** is formed in the inorganic passivation film **109**.

[0044] Next, the common electrode **111** is formed. As in the case of the pixel electrode **101**, the common electrode **111** is formed by sputtering ITO to have a thickness of e.g. 77 nm or 50 nm. At this time, the common electrode **111** and the capacitive electrode **108** are connected via the second through hole **110** formed in the inorganic passivation film **109**. Next, patterning is performed on the common electrode **111** formed on the entire surface. As shown in FIG. 1 or 2, the patterning of the common electrode **111** is made by forming the slit **112** with respect to the common electrode **111**. Accordingly, after the patterning of the common electrode **111**, the common electrode **111** exists on the entire surface except the slit part.

[0045] When a voltage is applied between the pixel electrode **101** and the common electrode **111**, an electric line of force as shown in FIG. 2 occurs, to rotate the liquid crystal molecule **200**. This controls the quantity of light passing through the liquid crystal layer by pixel, to form an image. Note that in FIG. 2, an orientation film to initially orient the liquid crystal formed on the common electrode **111** is omitted. Further, an opposite substrate (not shown) on which color filters and the like are formed, is provided to be opposite to the TFT substrate **100** in FIG. 2, with the liquid crystal layer therebetween.

[0046] The characteristic feature of the present invention is that it is possible to form the added capacitance **150** between the gate insulating film **103** and the pixel electrode **101** as shown in FIG. 2. In a case where the present invention is not used, the capacitance formed between the common electrode **111** and the pixel electrode **101** is formed, with the gate insulating film **103** and the inorganic passivation film **109** therebetween, as shown in FIG. 11. In this arrangement, it is not possible to obtain large added capacitance. In the present invention, in addition to the conventional added capacitance, the added capacitance **150** shown in FIG. 2 is added. Accordingly, it is possible to form large added capacitance as a whole and to reduce the influence on pixel voltage due to the variation of the gate voltage.

[0047] FIG. 5 illustrates an example of arrangement of the pixel in FIG. 1 described as above in matrix. In FIG. 5, to avoid complication of illustration, the common electrode **111** is omitted, and the TFT **30** is shown as a sign. In FIG. 5, the gate electrode **102** of the TFT **30** is connected to the main scan line **10**, and the drain electrode **106** is connected to the video signal line **20**. The capacitive electrode **108** forming the added capacitance **150** overlaps the pixel electrode **101** under

the pixel. The second through hole **110** connected to the common electrode **111** (not shown) is provided on the capacitive electrode **108**. Thus the added capacitance **150** is formed in each pixel.

**[0048]** FIG. **5** shows an example where the pixels are in-line arranged in the vertical direction. However, the present invention is also applicable to a so-called delta arrangement of the pixels. That is, in the delta arrangement (although not shown here), the position of a pixel is moved in the horizontal direction by half of the lateral dimension of the pixel per line. In this case, the video signal line **20** is bended per pixel line.

#### Second Embodiment

**[0049]** FIG. **5** shows a generally used pixel arrangement. In FIG. **5**, the video signal lines **20** exist in correspondence with the number of pixels in the horizontal direction. The required number of IC pins is the number of video signal lines **20**. The cost of the IC is greatly influenced by the number of pins. FIG. **6** shows a driving method in which the number of video signal lines **20** can be reduced to half the number of pixels in the horizontal direction.

**[0050]** In FIG. **6**, a pair of main scan lines **10** extends in the horizontal direction. The TFT **30** to supply the video signal alternately to the pixels arrayed in the horizontal direction is driven with the pair of the main scan lines **10**. The first pixel is driven with the upper main scan line **10**, and the second pixel is driven with the lower main scan line **10**. That is, one horizontal scan period is divided into two periods. In the first half period, the video signal is written with respect to the first pixel, and in the second half period, the video signal is written with respect to the second pixel.

**[0051]** In this method, the time to write the video signal with respect to each pixel is reduced to half. Further, the number of the main scan lines **10** is increased to double of that in a normal case. However, since the number of the main scan lines **10** is equal to or less than  $\frac{1}{3}$  of the number of the video signal lines **20**, the merit that the number of the video signal lines **20** becomes half is advantageous in the IC cost reduction. In the structure shown in FIG. **6**, the added capacitance **150** can be formed as in the case of the first embodiment. In the present embodiment, the position of the added capacitance **150** is reversed to its adjacent capacitance, although there is no problem in the characteristic.

#### Third Embodiment

**[0052]** FIG. **7** illustrates a pixel arrangement in a third embodiment of the present invention. The pixel driving method in FIG. **7** is the same as that described in FIG. **6**, having the merit that the number of the video signal lines **20** can be reduced to half. The characteristic feature in FIG. **7** is that it is possible to form the capacitive electrode **108** between adjacent pixels where no video signal line **20** exists and to further increase the added capacitance **150**.

**[0053]** In FIG. **7**, a shielding film is formed on the opposite substrate side so as to prevent light leakage even between pixels without the video signal line **20**. Accordingly, even when the capacitive electrode **108** is formed for the added capacitance **150** in this portion, the transmittance is not lowered. In FIG. **7**, the capacitive electrode **108** which overlaps the each pixel electrode **101** is formed between the adjacent first pixel and second pixel without the video signal line **20** therebetween.

**[0054]** In FIG. **7**, in the capacitive electrode **108**, the second through hole **110** connecting the common electrode **111** (not shown) to the capacitive electrode **108** is formed in the first pixel and the second pixel. It is not necessary to provide the through hole in the pixel, but may be provided between the first pixel and second pixel. Further, in FIG. **7**, the capacitive electrode **108** between the adjacent first pixel and second pixel is continuous, but it may be separated as needed.

#### Fourth Embodiment

**[0055]** In a Digital Still Camera (DSC) or the like, to increase the resolution, the pixel arrangement may be a delta arrangement. In the delta arrangement, it is advantageous to arrange the video signal line **20** alternately per pixel. In the DSC or the like, to raise the resolution, the number of the video signal lines **20** is increased, while, since the size of pixel is small, the video signal writing period is short.

**[0056]** FIG. **8** illustrates an example where the pixels are in the delta arrangement, and the video signal line **20** is arranged alternately per pixel in the horizontal direction. The arrangement in FIG. **8** is the same as that described in FIG. **6** except that the pixels are in the delta arrangement. Note that in FIG. **8**, for the delta arrangement of the pixels, the video signal line **20** is bended. The two main scan lines **10** in pair extend in the horizontal direction and the capacitive electrode **108** overlaps the pixel electrode **101**, as in the case of FIG. **6**.

#### Fifth Embodiment

**[0057]** FIG. **9** illustrates a pixel arrangement in a fifth embodiment of the present invention. In FIG. **9**, the pixel arrangement and driving method are the same as those in the fourth embodiment. The characteristic feature in FIG. **9** is that the capacitive electrode **108** is formed even between adjacent pixels without the video signal line **20**, and with this arrangement, the added capacitance **150** is further increased. The arrangement and advantageous point obtained with the capacitive electrode **108** are the same as those in FIG. **7** in the third embodiment.

**[0058]** In the delta arrangement, similarly to the third embodiment, a shielding film is formed on the opposite substrate side so as to prevent light leakage even between pixels without the video signal line **20**. Accordingly, even when the capacitive electrode **108** is formed for the added capacitance **150** in this portion, the transmittance is not decreased. In FIG. **9**, the capacitive electrode **108** which overlaps each pixel electrode **101** is formed between the adjacent first and second pixels without the video signal line **20**.

**[0059]** In FIG. **9**, the second through hole **110** connecting the common electrode **111** (not shown) to the capacitive electrode **108** is formed in the first and second pixels in the capacitive electrode **108**. The through hole is not necessarily provided in the pixel but may be provided between the first and second pixels. Further, in FIG. **9**, the capacitive electrode **108** between the adjacent first and second pixels is continuous, but it may be separated as needed.

**[0060]** As described above, in the IPS method with reduced number of layers, the variation of pixel potential due to ON/OFF of the gate voltage can be suppressed by applying the present invention to the delta arrangement pixel structure.

**[0061]** In the present invention, it is necessary to form the first through hole **104** in the gate insulating film **103** and form the second through hole in the inorganic passivation film **109**. In the inorganic passivation film **109**, however, since a

through hole is formed for formation of a terminal, the second through hole **110** can be formed at the same time of the formation of the terminal through hole. Further, in the gate insulating film **103**, since a through hole is often formed for formation of terminal, the first through hole **104** can be formed at the same time of the sputtering of terminal portion. Further, when the main scan line **10** driving circuit is included, since it is necessary to form a through hole in the gate insulating film **103**, the first through hole **104** can be formed simultaneously at this time.

What is claimed is:

**1.** A liquid crystal display device having a TFT substrate, an opposite substrate, and a liquid crystal between the TFT substrate and the opposite substrate;

wherein in the TFT substrate, there are formed in the following order;

a first pixel electrode and a second pixel electrode, a first scan line and a second scan line which extend in a first direction and are arranged in a second direction;

a first insulating film;

a first video signal line and a second signal line which extend in a second direction and are arranged in the first direction;

a second insulating film; and

a common electrode;

wherein the first pixel electrode and the second pixel electrode are formed in an area surrounded by the first scan line, the second scan line, the first video signal line and the second video signal line;

wherein the first video signal is supplied to the first pixel electrode through a first TFT driven by the first scan line, the second video signal is supplied to the second pixel electrode through a second TFT driven by the second scan line;

wherein the first pixel electrode and the second pixel electrode overlap with the common electrode;

wherein the liquid crystal is driven by an electric field formed between the common electrode and each of the first pixel electrode and the second pixel electrode;

wherein each of the first pixel electrode and the second pixel electrode forms an added capacitance with a capacitive electrode formed by a metal or an alloy via the first insulating film; and

wherein the capacitive electrode is electrically connected to the common electrode which is set between the first pixel electrode and the second pixel electrode in plan view, and overlaps with an edge of the first pixel electrode and an edge of the second pixel electrode.

**2.** A liquid crystal display device according to claim **1**,

Wherein the first pixel electrode and the second pixel electrode are arranged in an in-line arrangement in the second direction.

**3.** A liquid crystal display device according to claim **1**,

wherein the first pixel electrode and the second pixel electrode are arranged in a delta arrangement.

\* \* \* \* \*

|                |                                                                                                                                        |         |            |
|----------------|----------------------------------------------------------------------------------------------------------------------------------------|---------|------------|
| 专利名称(译)        | 液晶显示装置                                                                                                                                 |         |            |
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| 优先权            | 2010225632 2010-10-05 JP                                                                                                               |         |            |
| 其他公开文献         | US9329444                                                                                                                              |         |            |
| 外部链接           | <a href="#">Espacenet</a> <a href="#">USPTO</a>                                                                                        |         |            |

#### 摘要(译)

液晶显示装置包括TFT基板，相对基板和TFT基板与相对基板之间的液晶。在TFT基板中，按以下顺序形成第一像素电极和第二像素电极，第一扫描线 and 第二扫描线，它们沿第一方向延伸，并且我们沿第二方向排列，第一绝缘膜第一视频信号线和第二信号线，沿第二方向延伸并沿第一方向排列，第二绝缘膜和公共电极。第一像素电极和第二像素电极形成在由第一扫描线，第二扫描线，第一视频信号线和第二视频信号线围绕的区域中。

